



SYMBOLS	MIN.	NOM	MAX.
<div>4</div> A	—	—	3.40
A1	0.25	—	0.50
A2	2.57	2.72	2.87
b	—	0.30	—
c	0.10	0.15	0.20
D	23.65	23.90	24.15
D1	19.90	20.00	20.10
e	—	0.65	—
E	17.65	17.90	18.15
E1	13.90	14.00	14.10
L	0.65	0.80	0.95
L1	—	1.95	—
y	—	—	0.10
θ°	0	—	7

UNIT : mm

NOTES:

1.JEDEC OUTLINE:MO-112 CC-1

2.DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.

3.DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 mm PER SIDE. DIMENSIONS D1 AND E1 DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.

4.DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION .

拟 制		复 审	
审 核		会 签	
		标 准 化	
制 图		批 准	
幅 面: A4		比 例: 1:1	

更改标记	更改内容	签 名	日 期
<div><div><div></div><div></div><div></div><div></div></div><div>永嘉微电</div><div>Vinka Microelectronics</div></div>			
VKXHQP100V11_POD 产品外形图名称		图 号:VKXHQP100V11_POD	
		单 位	版 本
		mm	V1.1
		第 1 张	共 1 张
<div><div><div></div><div></div></div></div>			